

Data Sheet

January 2002

75A, 1200V Hyperfast Diode

The RHRG75120 is a hyperfast diode with soft recovery characteristics (t_{rr} < 85ns). It has half the recovery time of ultrafast diodes and is silicon nitride passivated ion-implanted epitaxial planar construction.

This device is intended for use as a freewheeling/clamping diode and rectifier in a variety of high frequency switching power supplies and other power switching applications. Its low stored charge and hyperfast soft recovery characteristic minimize ringing and electrical noise in many power switching circuits, thus reducing power loss in the switching transistors.

Formerly developmental type TA49042.

Ordering Information

PART NUMBER	PACKAGE	BRAND	
RHRG75120	TO-247	RHRG75120	

NOTE: When ordering, use the entire part number.

Symbol



Features

Hyperfast with Soft Recovery	
Operating Temperature	175°C
Reverse Voltage	1200V

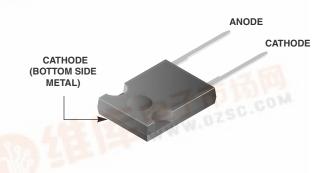
- Avalanche Energy Rated
- Planar Construction

Applications

- Switching Power Supplies
- Power Switching Circuits
- General Purpose

Packaging

JEDEC STYLE TO-247



Absolute Maximum Ratings T_C = 25°C

	RHRG75120	UNITS
Peak Repetitive Reverse Voltage	1200	V
Working Peak Reverse Voltage	1200	V
DC Blocking VoltageV _R	1200	V
Average Rectified Forward Current	75	Α
$(T_C = 42^{\circ}C)$		
Repetitive Peak Surge CurrentIFRM	150	Α
(Square Wave, 20kHz)		
(Square Wave, 20kHz) Nonrepetitive Peak Surge Current IFSM	500	Α
(Halfwave, 1 Phase, 60Hz)		
Maximum Power Dissipation	190	W
Avalanche Energy (See Figures 7 and 8)	50	mJ
Operating and Storage Temperature	-65 to 175	°C



RHRG75120

 $\textbf{Electrical Specifications} \hspace{0.5cm} \textbf{T}_{C} = 25^{o}\text{C}, \hspace{0.1cm} \textbf{Unless Otherwise Specified}$

SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNITS
V _F	I _F = 75A	-	-	3.2	V
	I _F = 75A, T _C = 150°C	-	-	2.6	V
I _R	V _R = 1200V	-	-	250	μΑ
	V _R = 1200V, T _C = 150 ^o C	-	-	2	mA
t _{rr}	I _F = 1A, dI _F /dt = 100A/μs	-	-	85	ns
	$I_F = 75A$, $dI_F/dt = 100A/\mu s$	-	-	100	ns
ta	$I_F = 75A$, $dI_F/dt = 100A/\mu s$	-	60	-	ns
t _b	$I_F = 75A$, $dI_F/dt = 100A/\mu s$	-	25	-	ns
$R_{ heta JC}$		-	-	0.8	°C/W

DEFINITIONS

 V_F = Instantaneous forward voltage (pw = 300 μ s, D = 2%).

 I_R = Instantaneous reverse current.

 t_{rr} = Reverse recovery time (See Figure 6), summation of t_a + t_b .

 t_a = Time to reach peak reverse current (See Figure 6).

 t_b = Time from peak I_{RM} to projected zero crossing of I_{RM} based on a straight line from peak I_{RM} through 25% of I_{RM} (See Figure 6).

 $R_{\theta JC}$ = Thermal resistance junction to case.

pw = Pulse width.

D = Duty cycle.

Typical Performance Curves

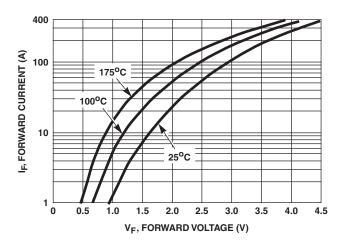


FIGURE 1. FORWARD CURRENT vs FORWARD VOLTAGE

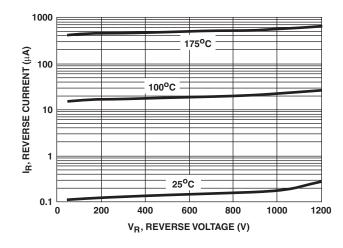


FIGURE 2. REVERSE CURRENT vs REVERSE VOLTAGE

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RHRG75120 Rev.

Typical Performance Curves (Continued)

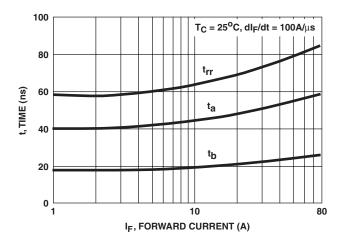


FIGURE 3. t_{rr} , t_a AND t_b CURVES vs FORWARD CURRENT

80 60 DC DC SQ. WAVE 20 25 50 75 100 125 150 175 T_C, CASE TEMPERATURE (°C)

FIGURE 4. CURRENT DERATING CURVE

Test Circuits and Waveforms

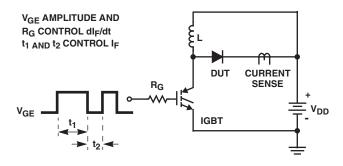


FIGURE 5. t_{rr} TEST CIRCUIT

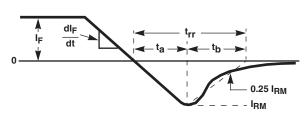


FIGURE 6. t_{rr} WAVEFORMS AND DEFINITIONS

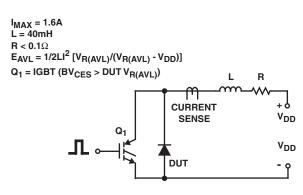


FIGURE 7. AVALANCHE ENERGY TEST CIRCUIT

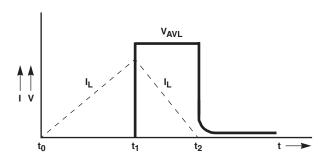


FIGURE 8. AVALANCHE CURRENT AND VOLTAGE WAVEFORMS

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